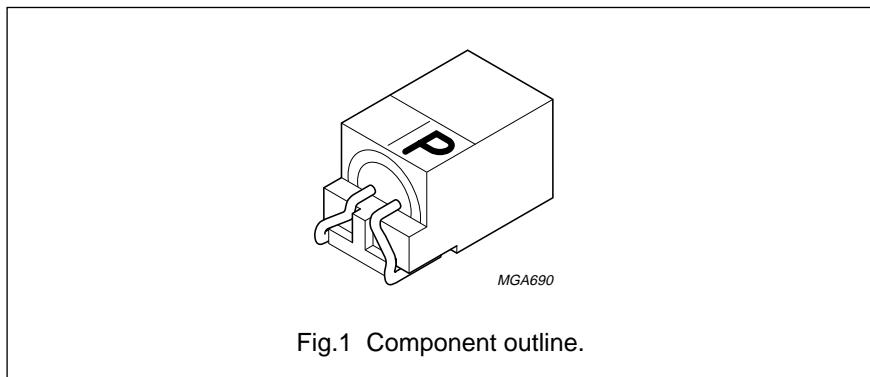


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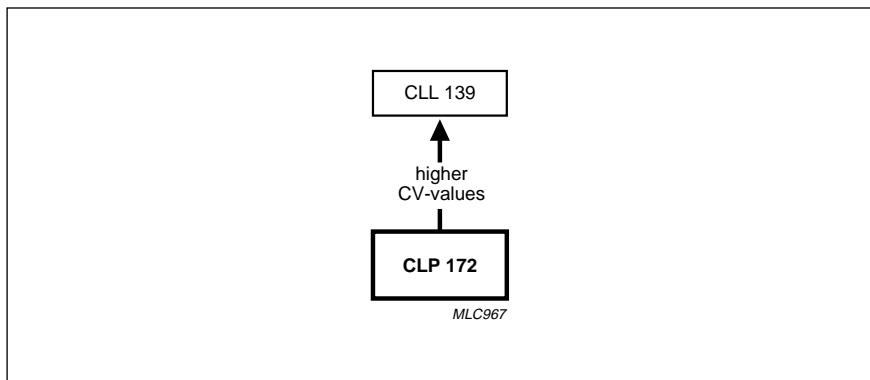
FEATURES

- Polarized aluminium electrolytic capacitors, non-solid, self healing
- SMD-version, for reflow soldering
- Miniaturized, high CV per unit volume, low height
- Charge and discharge proof, no peak current limitation
- Compact, rectangular shape
- Supplied in blister tape on reel.



APPLICATIONS

- SMD technology, boards/hybrids with restricted mounting height
- Coupling, decoupling, smoothing, filtering, buffering, timing
- Telecommunications, automotive, general industrial, low-profile and lightweight equipment.



QUICK REFERENCE DATA

DESCRIPTION	VALUE
Nominal case sizes (L × W × H in mm)	6.3 × 3.5 × 3.5 to 8.3 × 4.5 × 4.5
Rated capacitance range, C_R	1.0 to 33 μF
Tolerance on C_R	$\pm 20\%$
Rated voltage range, U_R	6.3 to 50 V
Category temperature range	-40 to +105 °C
Useful life at 105 °C	1000 hours
Useful life at 40 °C; $1.3 \times I_R$ applied	100000 hours
Shelf life at 0 V, 105 °C	500 hours
Based on sectional specification	IEC 384-18/CECC 32300
Climatic category IEC 68 (DIN 40040)	40/105/56 (GMF)

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Selection chart for C_R , U_R and relevant nominal case sizes ($L \times W \times H$ in mm)Preferred types in **bold**.

C_R (mF)	U_R (V)					
	6.3	10	16	25	35	50
1.0	–	–	–	–	–	$6.3 \times 3.5 \times 3.5$
2.2	–	–	–	–	$6.3 \times 3.5 \times 3.5$	$6.3 \times 4.0 \times 4.0$
3.3	–	–	–	$6.3 \times 3.5 \times 3.5$	–	$6.3 \times 4.5 \times 4.5$
4.7	–	–	$6.3 \times 3.5 \times 3.5$	$6.3 \times 4.0 \times 4.0$	$6.3 \times 4.5 \times 4.5$	$8.3 \times 4.5 \times 4.5$
6.8	–	$6.3 \times 3.5 \times 3.5$	–	$6.3 \times 4.5 \times 4.5$	$8.3 \times 4.5 \times 4.5$	–
10	$6.3 \times 3.5 \times 3.5$	–	$6.3 \times 4.0 \times 4.0$	$8.3 \times 4.5 \times 4.5$	–	–
15	–	$6.3 \times 4.5 \times 4.5$	$8.3 \times 4.5 \times 4.5$	–	–	–
22	$6.3 \times 4.5 \times 4.5$	$8.3 \times 4.5 \times 4.5$	–	–	–	–
33	$8.3 \times 4.5 \times 4.5$	–	–	–	–	–

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MECHANICAL DATA

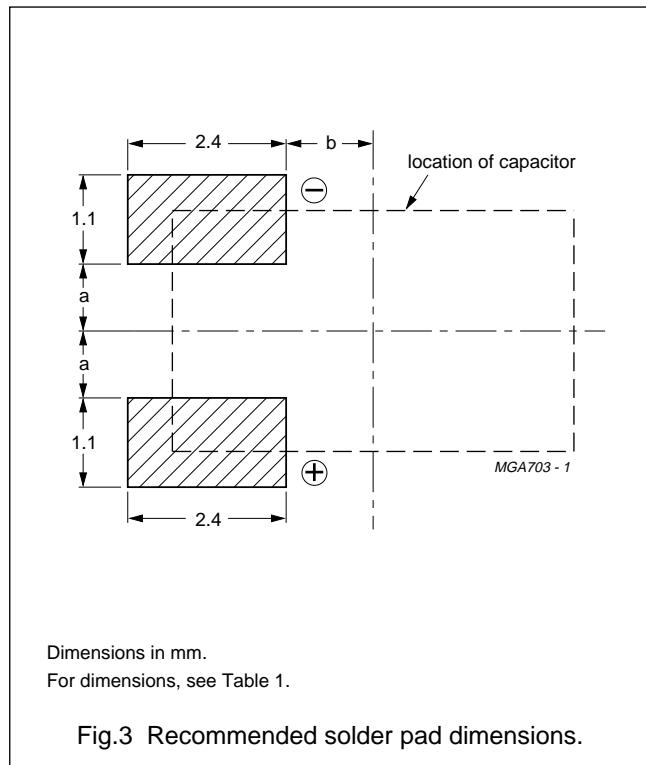
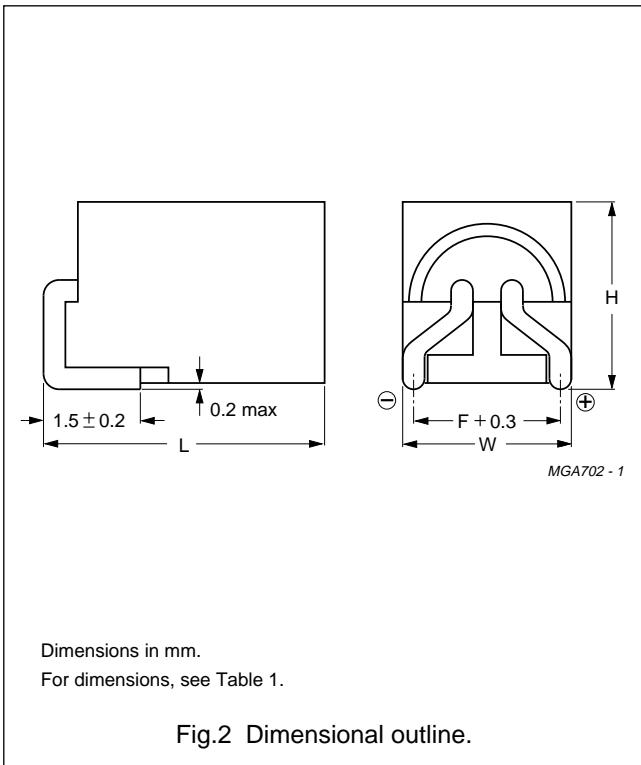


Table 1 Physical and recommended soldering pad dimensions, mass and packaging quantities; see Figs 2 and 3

NOMINAL CASE SIZE $L \times W \times H$ (mm)	CASE CODE	L_{max} (mm)	W_{max} (mm)	H_{max} (mm)	F (mm)	a (mm)	b (mm)	MASS (g)	PACKAGING QUANTITIES PER REEL
$6.3 \times 3.5 \times 3.5$	63	6.5	3.8	3.7	3.0	1.0	1.2	≈0.13	3000
$6.3 \times 4.0 \times 4.0$	64	6.5	4.3	4.2	3.5	1.3	1.2	≈0.17	2500
$6.3 \times 4.5 \times 4.5$	65	6.5	4.8	4.7	4.0	1.5	1.2	≈0.20	2500
$8.3 \times 4.5 \times 4.5$	85	8.5	4.8	4.7	4.0	1.5	2.2	≈0.25	2500

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MARKING

- Rated capacitance (in μF)
 - special capacitance markings:
 R2 = 0.22 μF
 R4 = 0.47 μF
- Rated voltage
- Name of manufacturer (P for PHILIPS)
- “–” sign indicating the cathode terminal.

MOUNTING

The capacitors are designed for automatic placement on to printed-circuit boards or hybrid circuits.

Optimum dimensions of soldering pads are dependent upon soldering method, mounting accuracy, print lay-out and/or adjacent components.

For recommended pad dimensions, refer to Fig.3 and Table 1.

Soldering

Soldering conditions are defined by the curve, temperature as a function of time. The temperature is that measured on the soldering pad during processing.

For maximum conditions of different soldering methods see Figs 4 and 5.

Any temperature versus time curve may be applied which does not exceed the specified maximum curves.

AS A GENERAL PRINCIPLE,
TEMPERATURE AND DURATION
SHALL BE THE **MINIMUM**
NECESSARY REQUIRED TO
ENSURE GOOD SOLDERING
CONNECTIONS.

Maximum temperature load

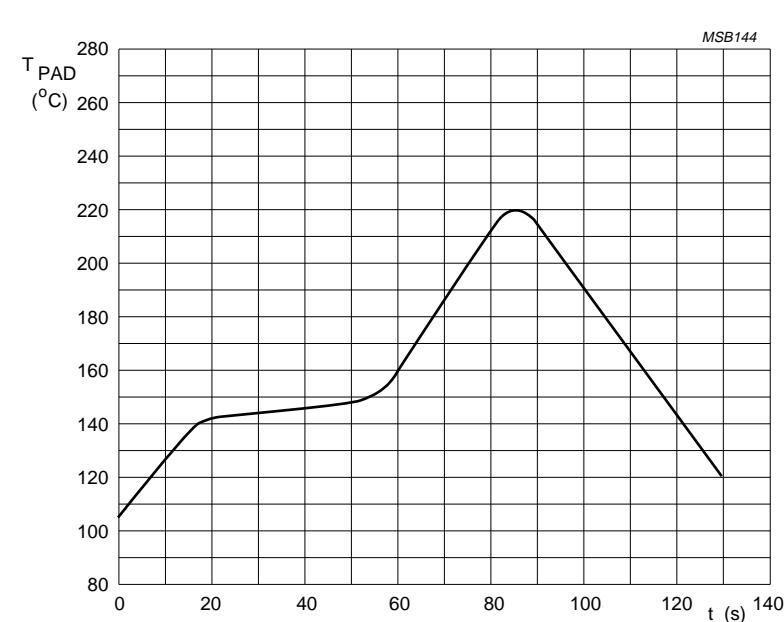


Fig.4 Maximum temperature load during infrared reflow soldering.

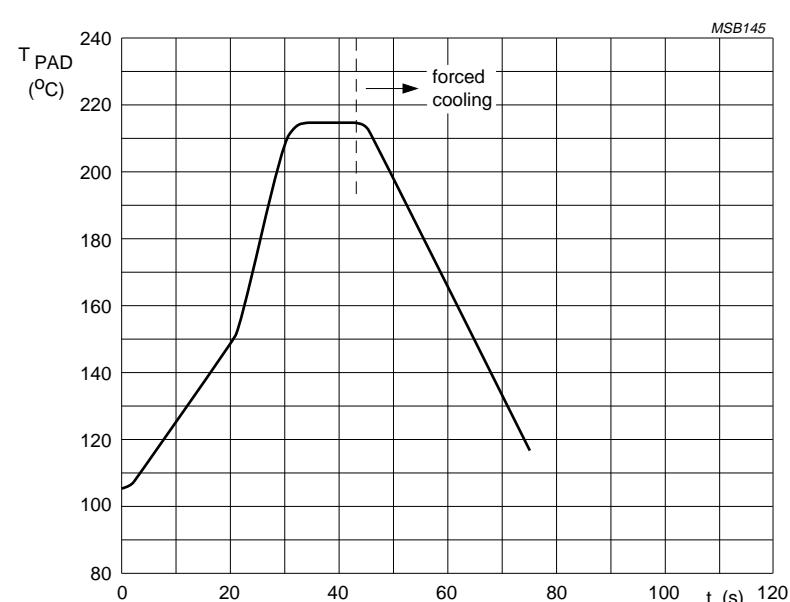


Fig.5 Maximum temperature load during vapour phase reflow soldering.

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ELECTRICAL DATA AND ORDERING INFORMATION

Unless otherwise specified, all electrical values in Table 2 apply at
 $T_{amb} = 20^{\circ}\text{C}$, $P = 86$ to 106 kPa , $RH = 45$ to 75% .

SYMBOL	DESCRIPTION
C_R	rated capacitance at 120 Hz, tolerance $\pm 20\%$
I_R	rated RMS ripple current at 120 Hz, 105°C
I_{L2}	max. leakage current after 2 minutes at U_R
$\tan \delta$	max. dissipation factor at 120 Hz
ESR	equivalent series resistance at 120 Hz (calculated from $\tan \delta_{max}$ and C_R)

Ordering example

Electrolytic capacitor CLP 172

10 $\mu\text{F}/16 \text{ V}; \pm 20\%$

Nominal case size:

 $6.3 \times 4.0 \times 4.0 \text{ mm}$; taped on reel

Catalogue number: 2222 172 65109

Table 2 Electrical data and ordering information; preferred types in **bold**

U_R (V)	C_R 120 Hz (μF)	NOMINAL CASE SIZE $L \times W \times H$ (mm)	CASE CODE	I_R 120 Hz 105°C (mA)	I_{L2} 2 min (μA)	$\tan \delta$ 120 Hz	ESR 120 Hz (Ω)	CATALOGUE NUMBER 2222
6.3	10	$6.3 \times 3.5 \times 3.5$	63	11	3	0.38	50	172 63109
	22	$6.3 \times 4.5 \times 4.5$	65	20	3	0.32	19	172 63229
	33	$8.3 \times 4.5 \times 4.5$	85	27	3	0.32	13	172 63339
10	6.8	$6.3 \times 3.5 \times 3.5$	63	10	3	0.30	59	172 64688
	15	$6.3 \times 4.5 \times 4.5$	65	19	3	0.28	25	172 64159
	22	$8.3 \times 4.5 \times 4.5$	85	25	3	0.28	17	172 64229
16	4.7	$6.3 \times 3.5 \times 3.5$	63	9	3	0.24	68	172 65478
	10	$6.3 \times 4.0 \times 4.0$	64	14	3	0.24	32	172 65109
	15	$8.3 \times 4.5 \times 4.5$	85	23	3	0.24	21	172 65159
25	3.3	$6.3 \times 3.5 \times 3.5$	63	8.3	3	0.18	72	172 66338
	4.7	$6.3 \times 4.0 \times 4.0$	64	11	3	0.18	51	172 66478
	6.8	$6.3 \times 4.5 \times 4.5$	65	16	3	0.16	31	172 66688
	10	$8.3 \times 4.5 \times 4.5$	85	21	3	0.16	21	172 66109
35	2.2	$6.3 \times 3.5 \times 3.5$	63	7.2	3	0.16	96	172 60228
	4.7	$6.3 \times 4.5 \times 4.5$	65	14	3	0.14	40	172 60478
	6.8	$8.3 \times 4.5 \times 4.5$	85	18	3	0.14	27	172 60688
50	1.0	$6.3 \times 3.5 \times 3.5$	63	5.2	3	0.14	190	172 61108
	2.2	$6.3 \times 4.0 \times 4.0$	64	8.4	3	0.14	84	172 61228
	3.3	$6.3 \times 4.5 \times 4.5$	65	13	3	0.12	48	172 61338
	4.7	$8.3 \times 4.5 \times 4.5$	85	16	3	0.12	34	172 61478

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Additional electrical data

PARAMETER	CONDITIONS	VALUE
Voltage		
Surge voltage for short periods		$U_s \leq 1.15 \times U_R$
Reverse voltage		$U_{rev} \leq 1 \text{ V}$
Current		
Leakage current	after 2 minutes at U_R	$I_{L2} \leq 0.01C_R \times U_R$ or $3 \mu\text{A}$, whichever is greater

Impedance (Z)**Table 3** Ratio of impedance at 120 Hz, between -25 and $+20 \text{ }^\circ\text{C}$

NOMINAL CASE SIZE $L \times W \times H$ (mm)	$Z_{-25 \text{ }^\circ\text{C}}/Z_{+20 \text{ }^\circ\text{C}}$ at U_R					
	6.3 V	10 V	16 V	25 V	35 V	50 V
6.3 \times 3.5 \times 3.5	6	4	3	2	2	2
6.3 \times 4.0 \times 4.0						
6.3 \times 4.5 \times 4.5	4	3	2	2	2	2
8.3 \times 4.5 \times 4.5						

Table 4 Ratio of impedance at 120 Hz, between -40 and $+20 \text{ }^\circ\text{C}$

NOMINAL CASE SIZE $L \times W \times H$ (mm)	$Z_{-40 \text{ }^\circ\text{C}}/Z_{+20 \text{ }^\circ\text{C}}$ at U_R					
	6.3 V	10 V	16 V	25 V	35 V	50 V
6.3 \times 3.5 \times 3.5	12	9	7	5	4	4
6.3 \times 4.0 \times 4.0						
6.3 \times 4.5 \times 4.5	10	8	6	4	3	3
8.3 \times 4.5 \times 4.5						

Non-solid Al - electrolytic capacitors

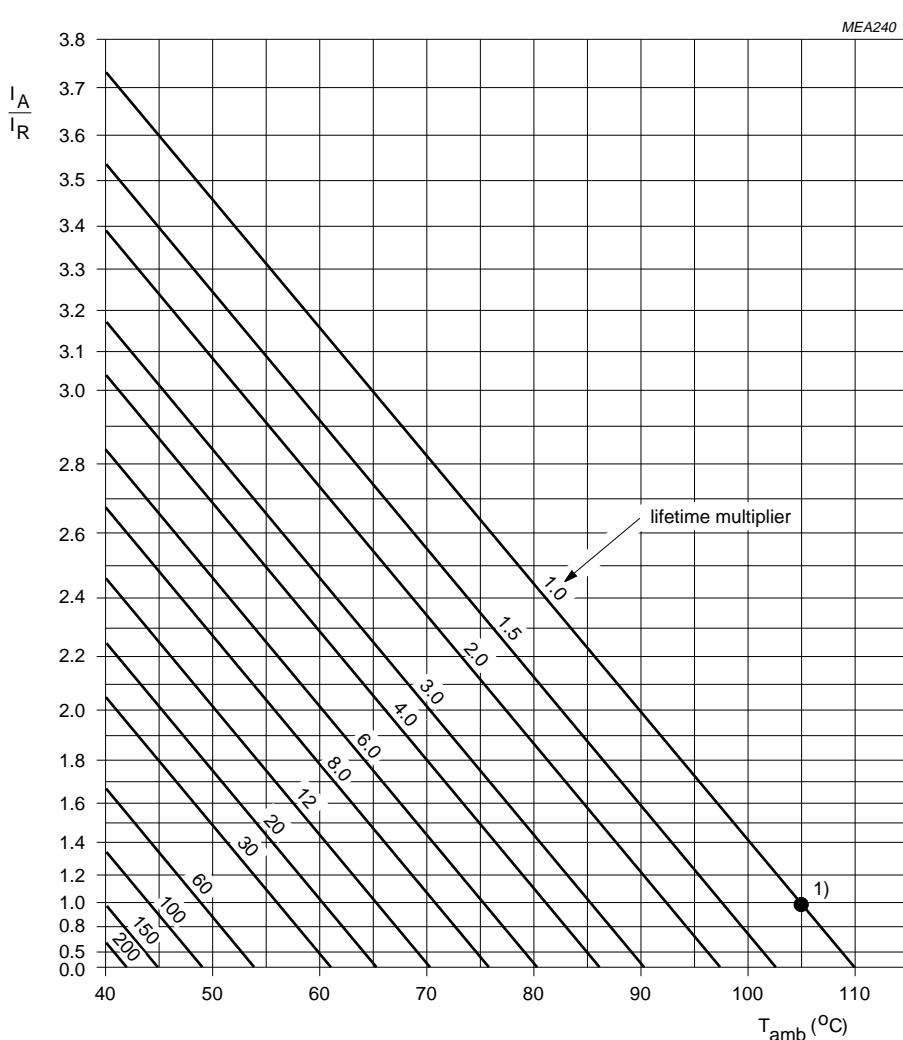
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RIPPLE CURRENT AND USEFUL LIFE

Table 5 Multiplier of ripple current (I_R) as a function of frequency

FREQUENCY (Hz)	I_R MULTIPLIER
50	0.6
120	1.0
400	1.2
800	1.3
≥ 2000	1.4



I_A = actual ripple current at 120 Hz.

I_R = ripple current at 105 °C, 120 Hz.

(1) Useful life at 105 °C and I_R applied: 1000 hours.

Fig.6 Multiplier of useful life as a function of ambient temperature and ripple current load.

Non-solid Al - electrolytic capacitors

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SPECIFIC TESTS AND REQUIREMENTS

General tests and requirements are specified in this handbook, section "*Tests and Requirements*".

Table 6 Test procedures and requirements

TEST		PROCEDURE (quick reference)	REQUIREMENTS
NAME OF TEST	REFERENCE		
Mounting	IEC 384-18, subclause 4.3	shall be performed prior to tests 'Useful life' and 'Shelf life' as mentioned below; reflow soldering; for maximum temperature load refer to Chapter "Mounting"	$\Delta C/C: \pm 8\%$ $\tan \delta \leq \text{spec. limit}$ $I_{L2} \leq 2 \times \text{spec. limit}$
Useful life	CECC 30301, subclause 1.8.1	$T_{amb} = 105^{\circ}\text{C}$; U_R and I_R applied; 1000 hours	$\Delta C/C:$ case codes 63 and 64: $\pm 25\%$ case codes 65 and 85: $\pm 20\%$ $\tan \delta \leq 2 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$ no short or open circuit total failure percentage: $\leq 1\%$
Shelf life (storage at high temperature)	IEC 384-18/ CECC 32300, subclause 4.17	$T_{amb} = 105^{\circ}\text{C}$; no voltage applied; 500 hours; after test: U_R to be applied for 30 minutes, 24 to 48 hours before measurement	$\Delta C/C:$ case codes 63 and 64: $\pm 25\%$ case codes 65 and 85: $\pm 15\%$ $\tan \delta:$ case codes 63 and 64: $\leq 2 \times \text{spec. limit}$ case codes 65 and 85: $\leq 1.5 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$